

STGP4M65DF2

Trench gate field-stop IGBT, M series 650 V, 4 A low loss

Datasheet - production data

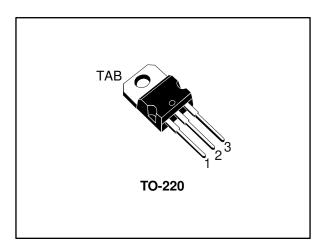
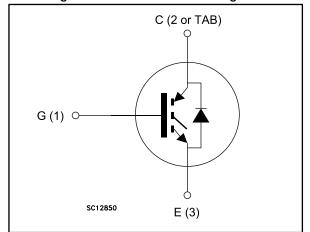


Figure 1: Internal schematic diagram



Features

- 6 μs of short-circuit withstand time
- V_{CE(sat)} = 1.6 V (typ.) @ I_C = 4 A
- Tight parameter distribution
- Safer paralleling
- Low thermal resistance
- Soft and very fast recovery antiparallel diode

Applications

- Motor control
- UPS
- PFC

Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive $V_{\text{CE(sat)}}$ temperature coefficient and tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

Order code	Marking	Package	Packing
STGP4M65DF2	G4M65DF2	TO-220	Tube

Contents STGP4M65DF2

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STGP4M65DF2 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vces	Collector-emitter voltage (V _{GE} = 0 V)	650	V
1-	Continuous collector current at T _C = 25 °C	8	Α
lc	Continuous collector current at T _C = 100 °C	4	Α
ICP ⁽¹⁾	Pulsed collector current	16	Α
V_{GE}	Gate-emitter voltage	±20	V
	Continuous forward current at T _C = 25 °C	8	Α
l _F	Continuous forward current at T _C = 100 °C	4	Α
I _{FP} ⁽¹⁾	Pulsed forward current	16	Α
Ртот	Total dissipation at T _C = 25 °C	68	W
Tstg	Storage temperature range - 55 to 150		°C
T_J	Operating junction temperature range	- 55 to 175	°C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
RthJC	Thermal resistance junction-case IGBT	2.2	°C/W
RthJC	Thermal resistance junction-case diode	5	°C/W
R _{thJA}	Thermal resistance junction-ambient	62.5	°C/W

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by maximum junction temperature.

Electrical characteristics STGP4M65DF2

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 4: Static characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$	650			٧
		$V_{GE} = 15 \text{ V}, I_{C} = 4 \text{ A}$		1.6	2.1	
V _{CE(sat)} Collector-emit voltage	Collector-emitter saturation	V _{GE} = 15 V, I _C = 4 A, T _J = 125 °C		1.9		٧
	voltage	V _{GE} = 15 V, I _C = 4 A, T _J = 175 °C		2.1		
		I _F = 4 A		1.9		
V_{F}	Forward on-voltage	I _F = 4 A, T _J = 125 °C		1.7		V
		I _F = 4 A, T _J = 175 °C		1.6		
$V_{\text{GE(th)}}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 250 \mu A$	5	6	7	V
I _{CES}	Collector cut-off current	V _{GE} = 0 V, V _{CE} = 650 V			25	μΑ
Iges	Gate-emitter leakage current	V _{CE} = 0 V, V _{GE} = ± 20 V			±250	μΑ

Table 5: Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		1	369	ı	
Coes	Output capacitance	V _{CE} = 25 V, f = 1 MHz,	1	24.8	1	рF
Cres	Reverse transfer capacitance	V _{GE} = 0 V	-	8	-	ρ.
Q_g	Total gate charge	$V_{CC} = 520 \text{ V}, I_C = 4 \text{ A},$	1	15.2	ı	
Q_{ge}	Gate-emitter charge	V _{GE} = 15 V (see <i>Figure 30: " Gate charge</i>	1	3	ı	nC
Q_{gc}	Gate-collector charge	test circuit")	-	7	-	

Table 6: IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time			12	-	ns
tr	Current rise time			6.9	-	ns
(di/dt) _{on}	Turn-on current slope	V _{CE} = 400 V, I _C = 4 A,		480	-	A/μs
t _{d(off)}	Turn-off-delay time	$V_{GE} = 15 \text{ V}, R_G = 47 \Omega$		86	-	ns
t _f	Current fall time	(see Figure 29: "Test circuit for inductive load		120	-	ns
E _{on} ⁽¹⁾	Turn-on switching energy	switching")		0.040	-	mJ
E _{off} (2)	Turn-off switching energy			0.136	-	mJ
Ets	Total switching energy			0.176	1	mJ
t _{d(on)}	Turn-on delay time			11.6	-	ns
tr	Current rise time			8	1	ns
(di/dt) _{on}	Turn-on current slope	$V_{CE} = 400 \text{ V}, I_{C} = 4 \text{ A},$		410	-	A/μs
t _{d(off)}	Turn-off-delay time	$V_{GE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $T_{J} = 175 \text{ °C}$		85	-	ns
tf	Current fall time	(see Figure 29: " Test circuit		211	1	ns
E _{on} ⁽¹⁾	Turn-on switching energy	for inductive load switching")		0.067	-	mJ
E _{off} (2)	Turn-off switching energy			0.210	-	mJ
Ets	Total switching energy			0.277	-	mJ
t _{sc}	Short-circuit withstand time	V _{CC} ≤ 400 V, V _{GE} = 15 V, T _{Jstart} = 150 °C	6		-	μs
		$V_{CC} \le 400 \text{ V}, V_{GE} = 13 \text{ V},$ $T_{Jstart} = 150 \text{ °C}$	10		-	μs

Notes:

Table 7: Diode switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
trr	Reverse recovery time		1	133	ı	ns
Qrr	Reverse recovery charge	$I_F = 4 A, V_R = 400 V,$	1	140	ı	nC
Irrm	Reverse recovery current	V _{GE} = 15 V, di/dt = 800 A/μs	1	5	1	Α
dl _{rr} /dt	Peak rate of fall of reverse recovery current during t_{b}	(see Figure 29: " Test circuit for inductive load switching")		520	ı	A/μs
Err	Reverse recovery energy			15	1	μJ
t _{rr}	Reverse recovery time		-	236	ı	ns
Qrr	Reverse recovery charge	I _F = 4 A, V _R = 400 V,	1	370	ı	nC
I _{rrm}	Reverse recovery current	V _{GE} = 15 V, T _J = 175 °C, di/dt = 800 A/μs	1	6.6	1	Α
dl _{rr} /dt	Peak rate of fall of reverse recovery current during tb	(see Figure 29: " Test circuit for inductive load switching")	1	378	ı	A/μs
Err	Reverse recovery energy		-	32	-	μJ

⁽¹⁾Including the reverse recovery of the diode.

 $[\]ensuremath{^{(2)}}\mbox{Including}$ the tail of the collector current.

2.1 Electrical characteristics (curves)

Figure 2: Power dissipation vs. case temperature

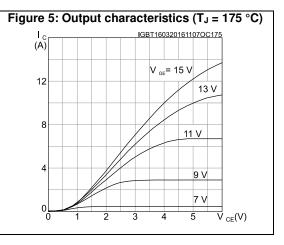
P_{TOT}
(W)
V_{GE} ≥15 V, T_J ≤175 °C

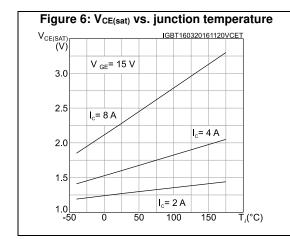
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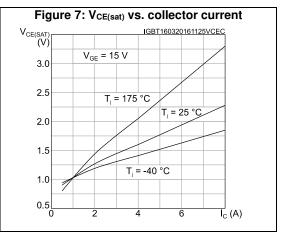
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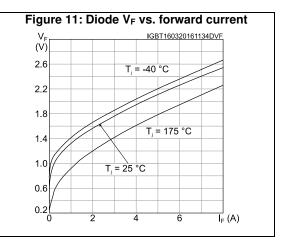
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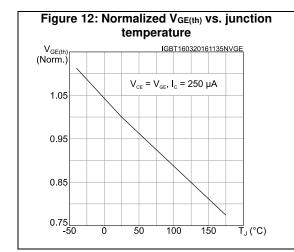
-50
0
50
100
150
T_C (°C)











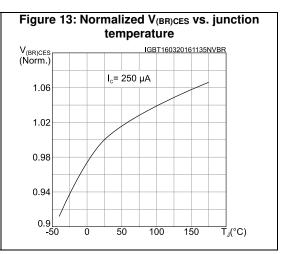


Figure 14: Capacitance variations

C
(pF)

10²

10¹

10⁰

10¹

10⁰

10¹

10⁰

10¹

10⁰

10¹

10⁰

10¹

10⁰

10¹

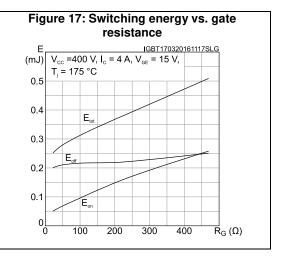
10²

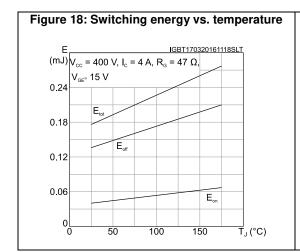
V_{CE} (V)

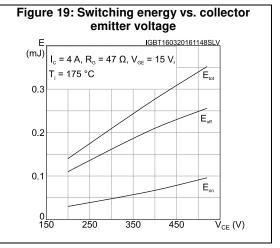
Figure 15: Gate charge vs. gate-emitter voltage

V_{GE}
(V)
(V_{CC} = 520 V, I_C = 4 A, I_G = 1 mA

15
12
9
6
3
0
3
6
9
12
15
Q_g (nC)







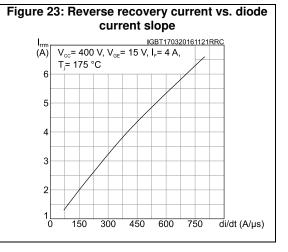
STGP4M65DF2 Electrical characteristics

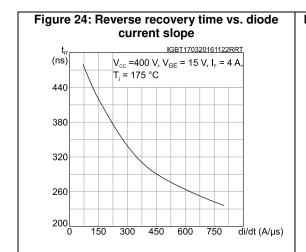
Figure 21: Switching times vs. collector current

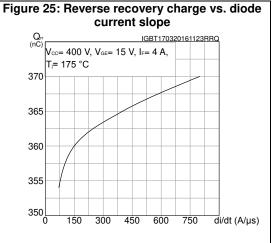
(ns) $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_G = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{CC} = 400 \text{ V$

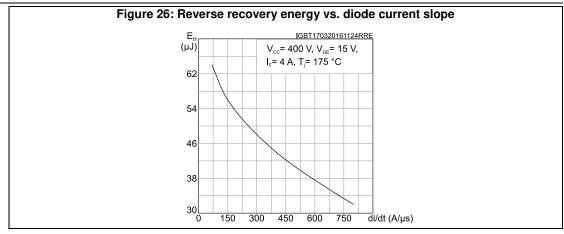
Figure 22: Switching times vs. gate resistance

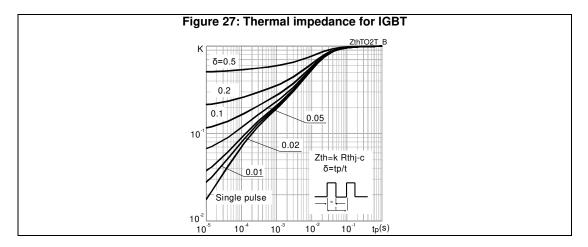
(ns) $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, I_{C} = 4 \text{ A}, I_{C} = 4 \text{ A$

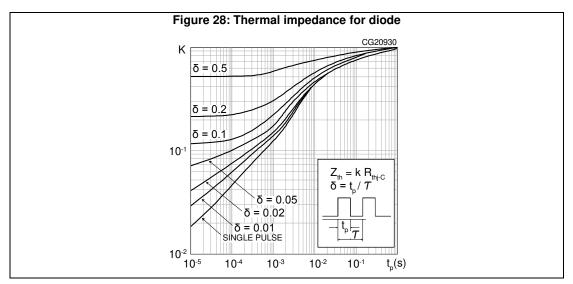






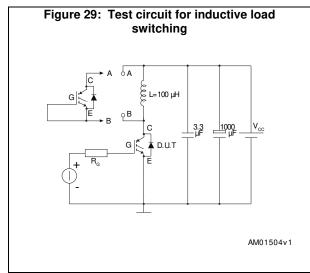


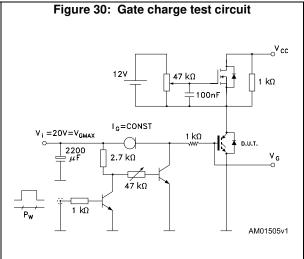


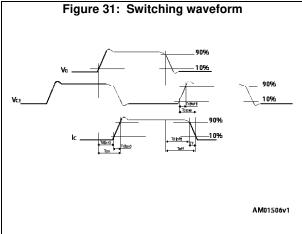


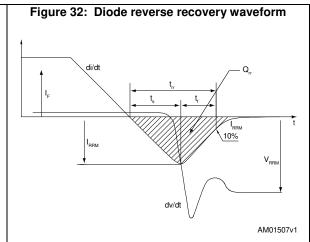
STGP4M65DF2 Test circuits

3 Test circuits









4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

STGP4M65DF2 Package information

4.1 TO-220 type A package information

Figure 33: TO-220 type A package outline

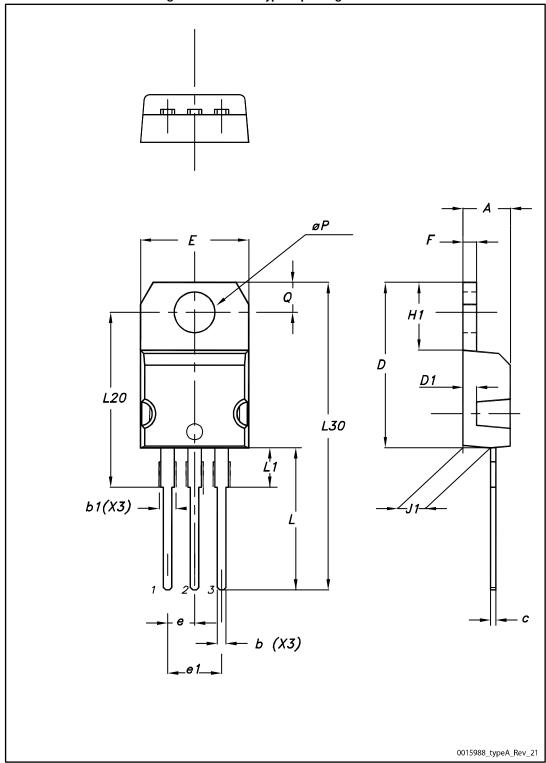


Table 8: TO-220 type A mechanical data

Dim	,	mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
С	0.48		0.70
D	15.25		15.75
D1		1.27	
Е	10.00		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øΡ	3.75		3.85
Q	2.65		2.95

STGP4M65DF2 Revision history

5 Revision history

Table 9: Document revision history

Date	Revision	Changes	
25-Nov-2015	1	First release.	
30-Mar-2016	2	Modified: features in cover page Datasheet promoted from preliminary data to production data Modified: Table 2: "Absolute maximum ratings", Table 4: "Static characteristics", Table 5: "Dynamic characteristics", Table 6: "IGBT switching characteristics (inductive load)" and Table 7: "Diode switching characteristics (inductive load)" Added: Section 2.1: "Electrical characteristics (curves)" Minor text changes	
21-Nov-2016	3	Updated Table 2: "Absolute maximum ratings" Updated Table 6: "IGBT switching characteristics (inductive load)" Updated Figure 25: "Reverse recovery charge vs. diode current slope" Minor text changes	

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